

ABSTRACT OF THE DISCLOSURE

A semiconductor manufacturing apparatus includes a light source, a lighting device for lighting the light source, and a connector for connecting the light source and the lighting device with a metal piece, whereby generation of noise accompanying increased electrical power supplied to the lamp is maintained at a level equal to or less than that of conventional arrangements, and the space required for installing increasingly larger semiconductor manufacturing apparatuses is maintained at a scale equal to or smaller than that of conventional arrangements, thereby lightening the overall task of installing the semiconductor manufacturing apparatus including cables, improving the efficiency of a cooling device (temperature-adjusting device), and reducing and thus conserving electrical power used for the cooling (temperature adjusting).

40044937 011502